Data Sheet

ADuM4400/ADuM4401/ADuM4402

5 kV RMS Quad-Channel Digital Isolators

FEATURES

- Enhanced system-level ESD performance per IEC 61000-4-x
- Safety and regulatory approvals (RI-16/RW-16 package)
  - UL 1577
    - V_{ISO} = 5000 V rms for 1 minute
  - IEC/EN/CSA 62368-1
  - IEC/CSA 60601-1
  - IEC/CSA 61010-1
  - CQC GB 4943.1
  - DIN EN IEC 60747-17 (VDE 0884-17)
    - V_{IORM} = 645 V peak
- Low power operation
  - 5 V operation
    - 1.4 mA per channel maximum @ 0 Mbps to 2 Mbps
    - 4.3 mA per channel maximum @ 10 Mbps
    - 34 mA per channel maximum @ 90 Mbps
  - 3.3 V operation
    - 0.9 mA per channel maximum @ 0 Mbps to 2 Mbps
    - 2.4 mA per channel maximum @ 10 Mbps
    - 20 mA per channel maximum @ 90 Mbps
- Bidirectional communication
- 3.3 V/5 V level translation
- High temperature operation: 105°C
- High data rate: dc to 90 Mbps (NRZ)
- Precise timing characteristics
  - 2 ns maximum pulse width distortion
  - 2 ns maximum channel-to-channel matching
- High common-mode transient immunity: >25 kV/µs
- Output enable function
- 16-lead SOIC wide body package version (RW-16)
- 16-lead SOIC wide body enhanced creepage version (RI-16)

APPLICATIONS

- General-purpose, high voltage, multichannel isolation
- Medical equipment
- Motor drives
- Power supplies

GENERAL DESCRIPTION

The ADuM440x[1] are 4-channel digital isolators based on the Analog Devices, Inc., *i*Coupler® technology. Combining high speed CMOS and monolithic air core transformer technology, these isolation components provide outstanding performance characteristics that are superior to the alternatives, such as optocoupler devices and other integrated couplers.

The ADuM440x isolators provide four independent isolation channels in a variety of channel configurations and data rates (see the Ordering Guide). All models operate with the supply voltage on either side ranging from 3.0 V to 5.5 V, providing compatibility with lower voltage systems as well as enabling a voltage translation functionality across the isolation barrier. The ADuM440x isolators have a patented refresh feature that ensures dc correctness in the absence of input logic transitions and during power-up/power-down conditions.

This family of isolators, like many Analog Devices isolators, offers very low power consumption, consuming one-tenth to one-sixth the power of comparable isolators at comparable data rates up to 10 Mbps. All models of the ADuM440x provide low pulse width distortion (<2 ns for C grade). In addition, every model has an input glitch filter to protect against extraneous noise disturbances.

The ADuM440x contain circuit and layout enhancements to help achieve system-level IEC 61000-4-x compliance (ESD/burst/surge). The precise capability in these tests for the ADuM440x are strongly determined by the design and layout of the user's board or module. For more information, see the AN-793 Application Note, *ESD/Latch-Up Considerations with iCoupler Isolation Products*.

[1] Protected by U.S. Patents 5,952,849; 6,873,065; and 7,075,329.

Rev. G

TABLE OF CONTENTS

REVISION HISTORY

2/2025—Rev. F to Rev. G

Changes to Features Section ... 1
Moved Figure 1 to Figure 3 ... 3
Changes to Regulatory Information Section and Table 14 ... 9
Changes to Table 15 ... 10
Changed DIN VVDEV 0884-10 (VDE V 0884-10) Insulation Characteristics Section to DIN EN IEC 60747-17 (VDE 0884-17) Insulation Characteristics Section ... 11
Changes to DIN EN IEC 60747-17 (VDE 0884-17) Insulation Characteristics Section, Table 16, and Figure 4 Caption ... 11
Changes to Table 19 ... 13
Changes to Insulation Lifetime Section ... 21
Deleted Figure 21 to Figure 23; Renumbered Sequentially ... 21
Added Number of Inputs, Maximum Data Rate, Maximum Propagation Delay, and Maximum Pulse Width Distortion Options ... 23

FUNCTIONAL BLOCK DIAGRAMS

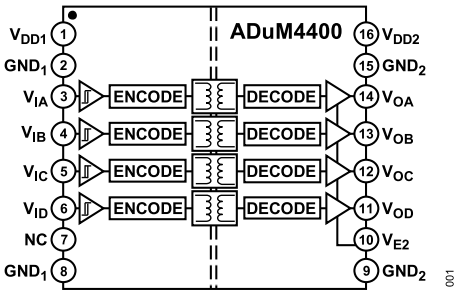


Figure 1. ADuM4400

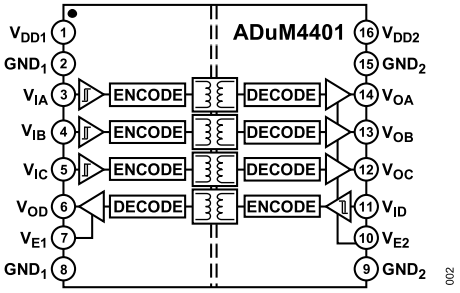


Figure 2. ADuM4401

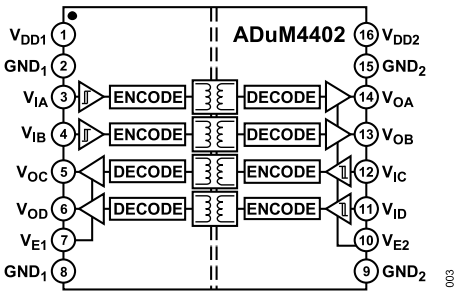


Figure 3. ADuM4402

SPECIFICATIONS

ELECTRICAL CHARACTERISTICS—5 V OPERATION

All typical specifications are at T_A = 25°C, V_{DD1} = V_{DD2} = 5 V. Minimum/maximum specifications apply over the entire recommended operation range of 4.5 V ≤ V_{DD1} ≤ 5.5 V, 4.5 V ≤ V_{DD2} ≤ 5.5 V, and −40°C ≤ T_A ≤ 105°C, unless otherwise noted. Switching specifications are tested with C_L = 15 pF and CMOS signal levels, unless otherwise noted.

Table 1.

		A Grade			B Grade			C Grade				
Parameter	**Symbol**	**Min**	**Typ**	**Max**	**Min**	**Typ**	**Max**	**Min**	**Typ**	**Max**	**Unit**	**Test Conditions**
SWITCHING SPECIFICATIONS												
Data Rate				1			10			90	Mbps	Within PWD limit
Propagation Delay	t_{PHL}, t_{PLH}	50	65	100	20	32	50	18	27	32	ns	50% input to 50% output
Pulse Width Distortion	PWD			40			3		0.5	2	ns	$\lvert t_{PLH} - t_{PHL} \rvert$
Change vs. Temperature			11			5			3		ps/°C	
Pulse Width	PW	1000			100			11.1			ns	Within PWD limit
Propagation Delay Skew	t_{PSK}			50			15			10	ns	Between any two units
Channel Matching												
Codirectional	t_{PSKCD}			50			3			2	ns	
Opposing-Direction	t_{PSKOD}			50			6			5	ns	

Table 2.

		1 Mbps—A, B, C Grades			10 Mbps—B, C Grades			90 Mbps—C Grade				
Parameter	**Symbol**	**Min**	**Typ**	**Max**	**Min**	**Typ**	**Max**	**Min**	**Typ**	**Max**	**Unit**	**Test Conditions**
SUPPLY CURRENT												
ADuM4400	I_{DD1}		2.9	3.5		9.0	11.6		72	100	mA	
	I_{DD2}		1.2	1.9		3.0	5.5		19	36	mA	
ADuM4401	I_{DD1}		2.5	3.2		7.4	10.6		59	82	mA	
	I_{DD2}		1.6	2.4		4.4	6.5		32	46	mA	
ADuM4402	I_{DD1}		2.0	2.8		6.0	7.5		51	62	mA	
	I_{DD2}		2.0	2.8		6.0	7.5		51	62	mA	

Table 3. For All Models

Parameter	**Symbol**	**Min**	**Typ**	**Max**	**Unit**	**Test Conditions**
DC SPECIFICATIONS						
Logic High Input Threshold	V_{IH}	2.0			V	
Logic Low Input Threshold	V_{IL}			0.8	V	
Logic High Output Voltage	V_{OH}	V_{DDx} − 0.1	5.0		V	I_{Ox} = −20 μA, V_{Ix} = V_{IxH}
		V_{DDx} − 0.4	4.8		V	I_{Ox} = −3.2 mA, V_{Ix} = V_{IxH}
Logic Low Output Voltage	V_{OL}		0.0	0.1	V	I_{Ox} = 20 μA, V_{Ix} = V_{IxL}
			0.04	0.1	V	I_{Ox} = 400 μA, V_{Ix} = V_{IxL}
			0.2	0.4	V	I_{Ox} = 3.2 mA, V_{Ix} = V_{IxL}
Input Current per Channel	I_I	−10	+0.01	+10	μA	0 V ≤ V_{Ix} ≤ V_{DDx}
Supply Current per Channel						
Quiescent Input Supply Current	$I_{DDI(Q)}$		0.57	0.83	mA	
Quiescent Output Supply Current	$I_{DDO(Q)}$		0.23	0.35	mA	
Dynamic Input Supply Current	$I_{DDI(D)}$		0.20		mA/Mbps	
Dynamic Output Supply Current	$I_{DDO(D)}$		0.05		mA/Mbps	
AC SPECIFICATIONS						
Output Rise/Fall Time	t_R/t_F		2.5		ns	10% to 90%
Common-Mode Transient Immunity[1]	|CM|	25	35		kV/μs	V_{Ix} = V_{DDx}, V_{CM} = 1000 V, transient magnitude = 800 V

SPECIFICATIONS

Table 3. For All Models (Continued)

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions
Output Disable Propagation Delay	t_{PHZ}, t_{PLH}		6	8	ns	High/low-to-high impedance
Output Enable Propagation Delay	t_{PZH}, t_{PZL}		6	8	ns	High impedance-to-high/low
Refresh Rate	f_r		1.2		Mbps	

[1] |CM| is the maximum common-mode voltage slew rate that can be sustained while maintaining $V_O > 0.8\ V_{DD}$. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

ELECTRICAL CHARACTERISTICS—3.3 V OPERATION

All typical specifications are at T_A = 25°C, $V_{DD1} = V_{DD2}$ = 3.3 V. Minimum/maximum specifications apply over the entire recommended operation range: 3.0 V ≤ V_{DD1} ≤ 3.6 V, 3.0 V ≤ V_{DD2} ≤ 3.6 V, and −40°C ≤ T_A ≤ 105°C, unless otherwise noted. Switching specifications are tested with C_L = 15 pF and CMOS signal levels, unless otherwise noted.

Table 4.

		A Grade			B Grade			C Grade				
Parameter	Symbol	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Unit	Test Conditions
SWITCHING SPECIFICATIONS												
Data Rate				1			10			90	Mbps	Within PWD limit
Propagation Delay	t_{PHL}, t_{PLH}	50	75	100	20	38	50	20	34	45	ns	50% input to 50% output
Pulse Width Distortion	PWD			40			3		0.5	2	ns	$\lvert t_{PLH} - t_{PHL} \rvert$
Change vs. Temperature			11			5			3		ps/°C	
Pulse Width	PW	1000			100			11.1			ns	Within PWD limit
Propagation Delay Skew	t_{PSK}			50			22			16	ns	Between any two units
Channel Matching												
Codirectional	t_{PSKCD}			50			3			2	ns	
Opposing-Direction	t_{PSKOD}			50			6			5	ns	

Table 5.

		1 Mbps—A, B, C Grades			10 Mbps—B, C Grades			90 Mbps—C Grade				
Parameter	Symbol	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Unit	Test Conditions
SUPPLY CURRENT												
ADuM4400	I_{DD1}		1.6	2.1		4.8	7.1		37	54	mA	
	I_{DD2}		0.7	1.2		1.8	2.3		11	15	mA	
ADuM4401	I_{DD1}		1.4	1.9		0.1	5.6		31	44	mA	
	I_{DD2}		0.9	1.5		2.5	3.3		17	24	mA	
ADuM4402	I_{DD1}		1.2	1.7		3.3	4.4		24	39	mA	
	I_{DD2}		1.2	1.7		3.3	4.4		24	39	mA	

Table 6. For All Models

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions
DC SPECIFICATIONS						
Logic High Input Threshold	V_{IH}	1.6			V	
Logic Low Input Threshold	V_{IL}			0.4	V	
Logic High Output Voltage	V_{OH}	V_{DDx} − 0.1	3.0		V	I_{Ox} = −20 μA, $V_{Ix} = V_{IxH}$
		V_{DDx} − 0.4	2.8		V	I_{Ox} = −3.2 mA, $V_{Ix} = V_{IxH}$
Logic Low Output Voltage	V_{OL}		0.0	0.1	V	I_{Ox} = 20 μA, $V_{Ix} = V_{IxL}$
			0.04	0.1	V	I_{Ox} = 400 μA, $V_{Ix} = V_{IxL}$
			0.2	0.4	V	I_{Ox} = 3.2 mA, $V_{Ix} = V_{IxL}$
Input Current per Channel	I_I	−10	+0.01	+10	μA	0 V ≤ V_{Ix} ≤ V_{DDx}

SPECIFICATIONS

Table 6. For All Models (Continued)

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions
Supply Current per Channel						
Quiescent Input Supply Current	$I_{DDI(Q)}$		0.31	0.49	mA	
Quiescent Output Supply Current	$I_{DDO(Q)}$		0.19	0.27	mA	
Dynamic Input Supply Current	$I_{DDI(D)}$		0.10		mA/Mbps	
Dynamic Output Supply Current	$I_{DDO(D)}$		0.03		mA/Mbps	
AC SPECIFICATIONS						
Output Rise/Fall Time	t_R/t_F		3		ns	10% to 90%
Common-Mode Transient Immunity[1]	|CM|	25	35		kV/µs	$V_{Ix} = V_{DDx}$, V_{CM} = 1000 V, transient magnitude = 800 V
Output Disable Propagation Delay	t_{PHZ}, t_{PLH}		6	8	ns	High/low-to-high impedance
Output Enable Propagation Delay	t_{PZH}, t_{PZL}		6	8	ns	High impedance-to-high/low
Refresh Rate	f_r		1.2		Mbps	

[1] |CM| is the maximum common-mode voltage slew rate that can be sustained while maintaining $V_O > 0.8\ V_{DD}$. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

ELECTRICAL CHARACTERISTICS—MIXED 5 V/3.3 V OPERATION

All typical specifications are at T_A = 25°C, V_{DD1} = 5 V, V_{DD2} = 3.3 V. Minimum/maximum specifications apply over the entire recommended operation range: 4.5 V ≤ V_{DD1} ≤ 5.5 V, 3.0 V ≤ V_{DD2} ≤ 3.6 V, and −40°C ≤ T_A ≤ 105°C, unless otherwise noted. Switching specifications are tested with C_L = 15 pF and CMOS signal levels, unless otherwise noted.

Table 7.

		A Grade			B Grade			C Grade				
Parameter	Symbol	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Unit	Test Conditions
SWITCHING SPECIFICATIONS												
Data Rate				1			10			90	Mbps	Within PWD limit
Propagation Delay	t_{PHL}, t_{PLH}	50	70	50	15	35	50	20	30	40	ns	50% input to 50% output
Pulse Width Distortion	PWD			40			3		0.5	2	ns	$\|t_{PLH} - t_{PHL}\|$
Change vs. Temperature			11			5			3		ps/°C	
Pulse Width	PW	1000			100			11.1			ns	Within PWD limit
Propagation Delay Skew	t_{PSK}			50			22			14	ns	Between any two units
Channel Matching												
Codirectional	t_{PSKCD}			50			3			2	ns	
Opposing-Direction	t_{PSKOD}			50			6			5	ns	

Table 8.

		1 Mbps—A, B, C Grades			10 Mbps—B, C Grades			90 Mbps—C Grade				
Parameter	Symbol	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Unit	Test Conditions
SUPPLY CURRENT												
ADuM4400	I_{DD1}		2.9	3.5		9.0	11.6		72	100	mA	
	I_{DD2}		0.7	1.2		1.8	2.3		11	15	mA	
ADuM4401	I_{DD1}		2.5	3.2		7.4	10.6		59	82	mA	
	I_{DD2}		0.9	1.5		2.5	3.3		17	24	mA	
ADuM4402	I_{DD1}		2.0	2.8		6.0	7.5		46	62	mA	
	I_{DD2}		1.2	1.7		3.3	4.4		24	39	mA	

SPECIFICATIONS

Table 9. For All Models

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions
DC SPECIFICATIONS						
Logic High Input Threshold	V_{IH}	2.0			V	
Logic Low Input Threshold	V_{IL}			0.8	V	
Logic High Output Voltage	V_{OH}	V_{DDx} − 0.1	3.0		V	I_{Ox} = −20 μA, V_{Ix} = V_{IxH}
		V_{DDx} − 0.4	2.8		V	I_{Ox} = −3.2 mA, V_{Ix} = V_{IxH}
Logic Low Output Voltage	V_{OL}		0.0	0.1	V	I_{Ox} = 20 μA, V_{Ix} = V_{IxL}
			0.04	0.1	V	I_{Ox} = 400 μA, V_{Ix} = V_{IxL}
			0.2	0.4	V	I_{Ox} = 3.2 mA, V_{Ix} = V_{IxL}
Input Current per Channel	I_I	−10	+0.01	+10	μA	0 V ≤ V_{Ix} ≤ V_{DDx}
Supply Current per Channel						
Quiescent Input Supply Current	$I_{DDI(Q)}$		0.57	0.83	mA	
Quiescent Output Supply Current	$I_{DDO(Q)}$		0.29	0.27	mA	
Dynamic Input Supply Current	$I_{DDI(D)}$		0.20		mA/Mbps	
Dynamic Output Supply Current	$I_{DDO(D)}$		0.03		mA/Mbps	
AC SPECIFICATIONS						
Output Rise/Fall Time	t_R/t_F		3		ns	10% to 90%
Common-Mode Transient Immunity[1]	|CM|	25	35		kV/μs	V_{Ix} = V_{DDx}, V_{CM} = 1000 V, transient magnitude = 800 V
Output Disable Propagation Delay	t_{PHZ}, t_{PLH}		6	8	ns	High/low-to-high impedance
Output Enable Propagation Delay	t_{PZH}, t_{PZL}		6	8	ns	High impedance-to-high/low
Refresh Rate	f_r		1.2		Mbps	

[1] |CM| is the maximum common-mode voltage slew rate that can be sustained while maintaining V_O > 0.8 V_{DD}. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

ELECTRICAL CHARACTERISTICS—MIXED 3.3 V/5 V OPERATION

All typical specifications are at T_A = 25°C, V_{DD1} = 3.3 V, V_{DD2} = 5 V. Minimum/maximum specifications apply over the entire recommended operation range: 3.0 V ≤ V_{DD1} ≤ 3.6 V, 4.5 V ≤ V_{DD2} ≤ 5.5 V, and −40°C ≤ T_A ≤ +105°C, unless otherwise noted. Switching specifications are tested with C_L = 15 pF and CMOS signal levels, unless otherwise noted.

Table 10.

		A Grade			B Grade			C Grade				
Parameter	Symbol	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Unit	Test Conditions
SWITCHING SPECIFICATIONS												
Data Rate				1			10			90	Mbps	Within PWD limit
Propagation Delay	t_{PHL}, t_{PLH}	50	70	100	15	35	50	20	30	40	ns	50% input to 50% output
Pulse Width Distortion	PWD			40			3		0.5	2	ns	|t_{PLH} − t_{PHL}|
Change vs. Temperature			11			5			3		ps/°C	
Pulse Width	PW	1000			100			11.1			ns	Within PWD limit
Propagation Delay Skew	t_{PSK}			50			22			14	ns	Between any two units
Channel Matching												
Codirectional	t_{PSKCD}			50			3			2	ns	
Opposing-Direction	t_{PSKOD}			50			6			5	ns	

SPECIFICATIONS

Table 11.

		1 MBps—A, B, C Grades			10 MBps—B, C Grades			90 MBps—C Grade				
Parameter	**Symbol**	**Min**	**Typ**	**Max**	**Min**	**Typ**	**Max**	**Min**	**Typ**	**Max**	**Unit**	**Test Conditions**
SUPPLY CURRENT												
ADuM4400	I_{DD1}		1.6	2.1		4.8	7.1		37	54	mA	
	I_{DD2}		1.2	1.9		3.0	5.5		19	36	mA	
ADuM4401	I_{DD1}		1.4	1.9		4.1	5.6		31	44	mA	
	I_{DD2}		1.6	2.4		4.4	6.5		32	46	mA	
ADuM4402	I_{DD1}		1.2	1.7		3.3	4.4		24	39	mA	
	I_{DD2}		2.0	2.8		6.0	7.5		46	62	mA	

Table 12. For All Models

Parameter	**Symbol**	**Min**	**Typ**	**Max**	**Unit**	**Test Conditions**
DC SPECIFICATIONS						
Logic High Input Threshold	V_{IH}	1.6			V	
Logic Low Input Threshold	V_{IL}			0.4	V	
Logic High Output Voltage	V_{OH}	V_{DDx} − 0.1	5.0		V	I_{Ox} = −20 μA, V_{Ix} = V_{IxH}
		V_{DDx} − 0.4	4.8		V	I_{Ox} = −3.2 mA, V_{Ix} = V_{IxH}
Logic Low Output Voltage	V_{OL}		0.0	0.1	V	I_{Ox} = 20 μA, V_{Ix} = V_{IxL}
			0.04	0.1	V	I_{Ox} = 400 μA, V_{Ix} = V_{IxL}
			0.2	0.4	V	I_{Ox} = 3.2 mA, V_{Ix} = V_{IxL}
Input Current per Channel	I_I	−10	+0.01	+10	μA	0 V ≤ V_{Ix} ≤ V_{DDx}
Supply Current per Channel						
Quiescent Input Supply Current	$I_{DDI(Q)}$		0.31	0.49	mA	
Quiescent Output Supply Current	$I_{DDO(Q)}$		0.19	0.35	mA	
Dynamic Input Supply Current	$I_{DDI(D)}$		0.10		mA/Mbps	
Dynamic Output Supply Current	$I_{DDO(D)}$		0.05		mA/Mbps	
AC SPECIFICATIONS						
Output Rise/Fall Time	t_R/t_F		2.5		ns	10% to 90%
Common-Mode Transient Immunity[1]	|CM|	25	35		kV/μs	V_{Ix} = V_{DDx}, V_{CM} = 1000 V, transient magnitude = 800 V
Output Disable Propagation Delay	t_{PHZ}, t_{PLH}		6	8	ns	High/low-to-high impedance
Output Enable Propagation Delay	t_{PZH}, t_{PZL}		6	8	ns	High impedance-to-high/low
Refresh Rate	f_r		1.1		Mbps	

[1] |CM| is the maximum common-mode voltage slew rate that can be sustained while maintaining V_O > 0.8 V_{DD}. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

SPECIFICATIONS

PACKAGE CHARACTERISTICS

Table 13.

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions
Resistance (Input to Output)[1]	R_{I-O}		10^{12}		Ω	
Capacitance (Input to Output)[1]	C_{I-O}		2.2		pF	f = 1 MHz
Input Capacitance[2]	C_I		4.0		pF	
IC Junction-to-Case Thermal Resistance, Side 1	θ_{JCI}		33		°C/W	Thermocouple located at center of package underside
IC Junction-to-Case Thermal Resistance, Side 2	θ_{JCO}		28		°C/W	

[1] Device considered a 2-terminal device: Pin 1, Pin 2, Pin 3, Pin 4, Pin 5, Pin 6, Pin 7, and Pin 8 shorted together and Pin 9, Pin 10, Pin 11, Pin 12, Pin 13, Pin 14, Pin 15, and Pin 16 shorted together.

[2] Input capacitance is from any input data pin to ground.

REGULATORY INFORMATION

The ADuM4400/ADuM4401/ADuM4402 RI-16/RW-16 certification approvals are listed in Table 14. Refer to Table 19 and the Insulation Lifetime section for details regarding recommended maximum working voltages for specific cross-isolation waveforms and insulation levels.

Table 14.

UL	CSA	VDE	CQC
1577[1] Single Protection, 5000 V rms	RW-16 package IEC/EN/CSA 62368-1 Basic insulation, 780 V rms Reinforced insulation, 390 V rms IEC/CSA 61010-1 Basic insulation, 600 V rms, overvoltage category III Reinforced insulation, 300 V rms, overvoltage category II IEC/CSA 60601-1 Reinforced insulation (2 MOPP), 125 V rms RI-16 package IEC/EN/CSA 62368-1 Basic insulation, 870 V rms Reinforced insulation, 435 V rms IEC/CSA 60601-1 Basic insulation, 600 V rms, overvoltage category IV Reinforced insulation, 300 V rms IEC/CSA 61010-1 Reinforced insulation (2 MOPP), 250 V rms	DIN EN IEC 60747-17 (VDE 0884-17)[2] Reinforced insulation, 645 V peak	CQC GB 4943.1 RW-16 package Basic insulation, 760 V rms Reinforced insulation, 380 V rms RI-16 package Basic insulation, 820 V rms Reinforced insulation, 410 V rms
File E214100	File No. 205078	Certificate No. 40011599	Certificate No. CQC16001150402

[1] In accordance with UL1577, each ADuM4400/ADuM4401/ADuM4402 RI-16/RW-16 is proof tested by applying an insulation test voltage ≥ 6000 V rms for 1 second (current leakage detection limit = 10 µA).

[2] In accordance with DIN EN IEC 60747-17 (VDE 0884-17), each ADuM4400/ADuM4401/ADuM4402 RI-16/RW-16 is proof tested by applying an insulation test voltage ≥1209 V peak for 1 sec (partial discharge detection limit = 5 pC). The * marking branded on the component designates DIN EN IEC 60747-17 (VDE 0884-17) approval.

SPECIFICATIONS

INSULATION AND SAFETY-RELATED SPECIFICATIONS

Table 15.

Parameter	Symbol	Value	Unit	Conditions
Rated Dielectric Insulation Voltage		5000	V rms	1-minute duration
Minimum External Air Gap (Clearance) RW-16 Package[1, 2]	L(I01)	7.8	mm	Distance measured from input terminals to output terminals, shortest distance through air along the PCB mounting plane, as an aid to PC board layout
Minimum External Air Gap (Clearance) RI-16 Package[1, 2]	L(I01)	8.7	mm	Distance measured from input terminals to output terminals, shortest distance through air along the PCB mounting plane, as an aid to PC board layout
Minimum External Tracking (Creepage) RW-16 Package[1]	L(I02)	7.8	mm	Measured from input terminals to output terminals, shortest distance path along body
Minimum External Tracking (Creepage) RI-16 Package[1]	L(I02)	8.7	mm	Measured from input terminals to output terminals, shortest distance path along body
Minimum Internal Gap (Internal Clearance)		18	µm	Insulation distance through insulation
Tracking Resistance (Comparative Tracking Index)[3]	CTI	>400	V	DIN IEC 112/VDE 0303 Part 1
Material Group		II		

[1] In accordance with IEC 62368-1/IEC 60601-1 guidelines for the measurement of creepage and clearance distances for a pollution degree of 2 and altitudes ≤2000 m.

[2] Consideration must be given to pad layout to ensure the minimum required distance for clearance is maintained.

[3] CTI rating for the ADuM4400/ADuM4401/ADuM4402 RI-16/RW-16 is >400V and a Material Group II isolation group.

SPECIFICATIONS

DIN EN IEC 60747-17 (VDE 0884-17) INSULATION CHARACTERISTICS

These isolators are suitable for reinforced electrical isolation only within the safety limit data. Maintenance of the safety data is ensured by means of protective circuits.

Note that the * marking on packages denotes DIN EN IEC 60747-17 (VDE 0884-17) approval.

Table 16.

Description	Conditions	Symbol	Characteristic	Unit
Installation Classification per DIN VDE 0110				
For Rated Mains Voltage ≤ 300 V rms			I to IV	
For Rated Mains Voltage ≤ 450 V rms			I to II	
For Rated Mains Voltage ≤ 600 V rms			I to II	
Climatic Classification			40/105/21	
Pollution Degree (DIN VDE 0110, Table 1)			2	
Maximum Repetitive Isolation Voltage		V_{IORM}	645	V peak
Maximum Working Insulation Voltage		V_{IOWM}	456	V rms
Input-to-Output Test Voltage, Method B1	V_{IORM} × 1.875 = $V_{pd(m)}$, 100% production test, t_m = 1 sec, partial discharge < 5 pC	$V_{pd(m)}$	1209	V peak
Input-to-Output Test Voltage, Method A		$V_{pd(m)}$		
After Environmental Tests Subgroup 1	V_{IORM} × 1.6 = $V_{pd(m)}$, t_m = 60 sec, partial discharge < 5 pC		1032	V peak
After Input and/or Safety Test Subgroup 2 and Subgroup 3	V_{IORM} × 1.2 = $V_{pd(m)}$, t_m = 60 sec, partial discharge < 5 pC		774	V peak
Maximum Transient Isolation Voltage	V_{TEST} = 1.2 × V_{IOTM}, t = 1 s (100% production)	V_{IOTM}	6000	V peak
Maximum Impulse Voltage	Surge voltage in air, waveform per IEC 61000-4-5	V_{IMP}	6000	V peak
Maximum Surge Isolation Voltage	V_{TEST} ≥ 1.3 × V_{IMP} (sample test), tested in oil, waveform per IEC 61000-4-5	V_{IOSM}	10,000	V peak
Safety-Limiting Values	Maximum value allowed in the event of a failure; see Figure 4			
Case Temperature		T_S	150	°C
Side 1 Current		I_{S1}	265	mA
Side 2 Current		I_{S2}	335	mA
Insulation Resistance at T_S	V_{IO} = 500 V	R_S	$>10^9$	Ω

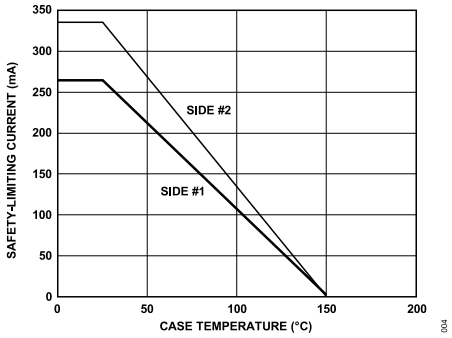


Figure 4. Thermal Derating Curve, Dependence of Safety Limiting Values with Case Temperature per DIN EN IEC 60747-17 (VDE 0884-17)

SPECIFICATIONS

RECOMMENDED OPERATING CONDITIONS

Table 17.

Parameter	Symbol	Min	Max	Unit
Operating Temperature	T_A	−40	+105	°C
Supply Voltages[1]	V_{DD1}, V_{DD2}	3.0	5.5	V
Input Signal Rise and Fall Times			1.0	ms

[1] All voltages are relative to their respective ground.

ABSOLUTE MAXIMUM RATINGS

Table 18.

Parameter	Rating
Storage Temperature (T_{ST})	−65°C to +150°C
Ambient Operating Temperature (T_A)	−40°C to +105°C
Supply Voltages (V_{DD1}, V_{DD2})[1]	−0.5 V to +7.0 V
Input Voltage (V_{IA}, V_{IB}, V_{IC}, V_{ID}, V_{E1}, V_{E2})[1, 2]	−0.5 V to V_{DDI} + 0.5 V
Output Voltage (V_{OA}, V_{OB}, V_{OC}, V_{OD})[1, 2]	−0.5 V to V_{DDO} + 0.5 V
Average Output Current Per Pin[3]	
Side 1 (I_{O1})	−18 mA to +18 mA
Side 2 (I_{O2})	−22 mA to +22 mA
Common-Mode Transients[4]	−100 kV/µs to +100 kV/µs

1 All voltages are relative to their respective ground.

2 V_{DDI} and V_{DDO} refer to the supply voltages on the input and output sides of a given channel, respectively. See the PC Board Layout section.

3 See Figure 4 for maximum rated current values for various temperatures.

4 Refers to common-mode transients across the insulation barrier. Common-mode transients exceeding the Absolute Maximum Rating can cause latch-up or permanent damage.

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

MAXIMUM CONTINUOUS WORKING VOLTAGE

Table 19. Maximum Continuous Working Voltage[1]

Parameter	Max	Unit	Constraint
AC Voltage			
Bipolar Waveform	645	V peak	Reinforced insulation rating per IEC 60747-17 (VDE 0884-17)

1 Refers to continuous voltage magnitude imposed across the isolation barrier. See the Insulation Lifetime section for more details.

TRUTH TABLE

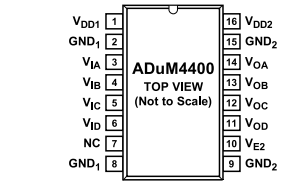
Table 20. Truth Table (Positive Logic)

V_{Ix} Input[1]	V_{Ex} Input[1, 2]	V_{DDI} State[1]	V_{DDO} State[1]	V_{Ox} Output[1]	Notes
H	H or NC	Powered	Powered	H	
L	H or NC	Powered	Powered	L	
X	L	Powered	Powered	Z	
X	H or NC	Unpowered	Powered	H	Outputs return to the input state within 1 µs of V_{DDI} power restoration.
X	L	Unpowered	Powered	Z	
X	X	Powered	Unpowered	Indeterminate	Outputs return to the input state within 1 µs of V_{DDO} power restoration if the V_{Ex} state is H or NC. Outputs return to a high impedance state within 8 ns of V_{DDO} power restoration if the V_{Ex} state is L.

1 V_{Ix} and V_{Ox} refer to the input and output signals of a given channel (A, B, C, or D). V_{Ex} refers to the output enable signal on the same side as the V_{Ox} outputs. V_{DDI} and V_{DDO} refer to the supply voltages on the input and output sides of the given channel, respectively.

2 In noisy environments, connecting V_{Ex} to an external logic high or low is recommended.

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS



NOTES
1. NC = NO CONNECT
2. PIN 2 AND PIN 8 ARE INTERNALLY CONNECTED, AND CONNECTING BOTH TO GND_1 IS RECOMMENDED.
3. PIN 9 AND PIN 15 ARE INTERNALLY CONNECTED, AND CONNECTING BOTH TO GND_2 IS RECOMMENDED.

Figure 5. ADuM4400 Pin Configuration

Table 21. ADuM4400 Pin Function Descriptions

Pin No.	Mnemonic	Description
1	V_{DD1}	Supply Voltage for Isolator Side 1, 3.0 V to 5.5 V.
2	GND_1	Ground 1. Ground reference for isolator Side 1.
3	V_{IA}	Logic Input A.
4	V_{IB}	Logic Input B.
5	V_{IC}	Logic Input C.
6	V_{ID}	Logic Input D.
7	NC	No Connect.
8	GND_1	Ground 1. Ground reference for isolator Side 1.
9	GND_2	Ground 2. Ground reference for isolator Side 2.
10	V_{E2}	Output Enable 2. Active high logic input. V_{Ox} outputs on Side 2 are enabled when V_{E2} is high or disconnected. V_{Ox} Side 2 outputs are disabled when V_{E2} is low. In noisy environments, connecting V_{E2} to an external logic high or low is recommended.
11	V_{OD}	Logic Output D.
12	V_{OC}	Logic Output C.
13	V_{OB}	Logic Output B.
14	V_{OA}	Logic Output A.
15	GND_2	Ground 2. Ground reference for isolator Side 2.
16	V_{DD2}	Supply Voltage for Isolator Side 2, 3.0 V to 5.5 V.

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

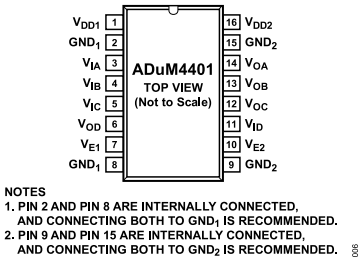
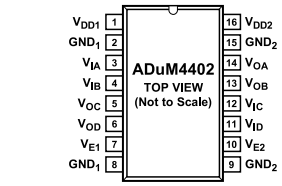


Figure 6. ADuM4401 Pin Configuration

Table 22. ADuM4401 Pin Function Descriptions

Pin No.	Mnemonic	Description
1	V_{DD1}	Supply Voltage for Isolator Side 1, 3.0 V to 5.5 V.
2	GND_1	Ground 1. Ground reference for isolator Side 1.
3	V_{IA}	Logic Input A.
4	V_{IB}	Logic Input B.
5	V_{IC}	Logic Input C.
6	V_{OD}	Logic Output D.
7	V_{E1}	Output Enable. Active high logic input. V_{Ox} Side 1 outputs are enabled when V_{E1} is high or disconnected. V_{OX} Side 1 outputs are disabled when V_{E1} is low. In noisy environments, connecting V_{E1} to an external logic high or low is recommended.
8	GND_1	Ground 1. Ground reference for isolator Side 1.
9	GND_2	Ground 2. Ground reference for isolator Side 2.
10	V_{E2}	Output Enable 2. Active high logic input. V_{Ox} outputs on Side 2 are enabled when V_{E2} is high or disconnected. V_{Ox} Side 2 outputs are disabled when V_{E2} is low. In noisy environments, connecting V_{E2} to an external logic high or low is recommended.
11	V_{ID}	Logic Input D.
12	V_{OC}	Logic Output C.
13	V_{OB}	Logic Output B.
14	V_{OA}	Logic Output A.
15	GND_2	Ground 2. Ground reference for isolator Side 2.
16	V_{DD2}	Supply Voltage for Isolator Side 2, 3.0 V to 5.5 V.

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS



NOTES
1. PIN 2 AND PIN 8 ARE INTERNALLY CONNECTED, AND CONNECTING BOTH TO GND_1 IS RECOMMENDED.
2. PIN 9 AND PIN 15 ARE INTERNALLY CONNECTED, AND CONNECTING BOTH TO GND_2 IS RECOMMENDED.

007

Figure 7. ADuM4402 Pin Configuration

Table 23. ADuM4402 Pin Function Descriptions

Pin No.	Mnemonic	Description
1	V_{DD1}	Supply Voltage for Isolator Side 1, 3.0 V to 5.5 V.
2	GND_1	Ground 1. Ground reference for isolator Side 1.
3	V_{IA}	Logic Input A.
4	V_{IB}	Logic Input B.
5	V_{OC}	Logic Output C.
6	V_{OD}	Logic Output D.
7	V_{E1}	Output Enable 1. Active high logic input. V_{Ox} Side 1 outputs are enabled when V_{E1} is high or disconnected. V_{OX} Side 1 outputs are disabled when V_{E1} is low. In noisy environments, connecting V_{E1} to an external logic high or low is recommended.
8	GND_1	Ground 1. Ground reference for isolator Side 1.
9	GND_2	Ground 2. Ground reference for isolator Side 2.
10	V_{E2}	Output Enable 2. Active high logic input. V_{Ox} outputs on Side 2 are enabled when V_{E2} is high or disconnected. V_{Ox} Side 2 outputs are disabled when V_{E2} is low. In noisy environments, connecting V_{E2} to an external logic high or low is recommended.
11	V_{ID}	Logic Input D.
12	V_{IC}	Logic Input C.
13	V_{OB}	Logic Output B.
14	V_{OA}	Logic Output A.
15	GND_2	Ground 2. Ground reference for isolator Side 2.
16	V_{DD2}	Supply Voltage for Isolator Side 2, 3.0 V to 5.5 V.

TYPICAL PERFORMANCE CHARACTERISTICS

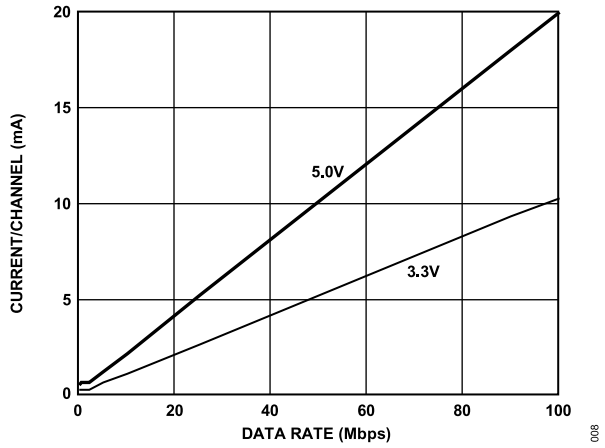


Figure 8. Typical Input Supply Current per Channel vs. Data Rate (No Load)

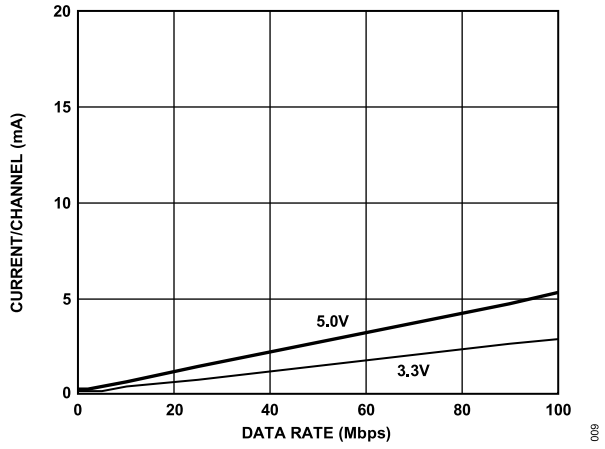


Figure 9. Typical Output Supply Current per Channel vs. Data Rate (No Load)

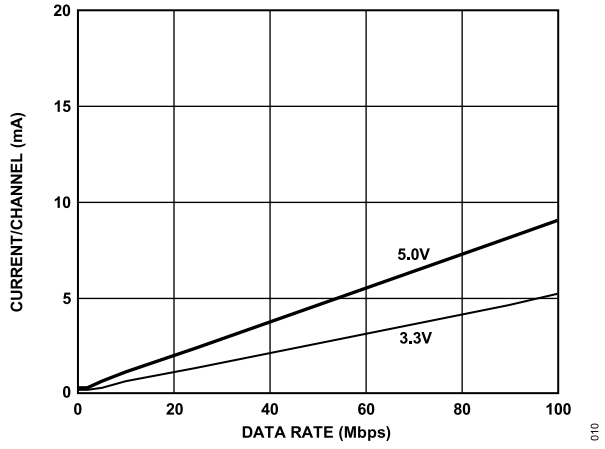


Figure 10. Typical Output Supply Current per Channel vs. Data Rate (15 pF Output Load)

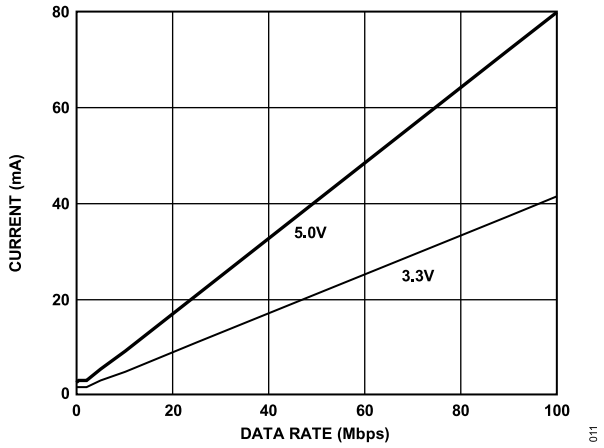


Figure 11. Typical ADuM4400 V_{DD1} Supply Current vs. Data Rate for 5 V and 3.3 V Operation

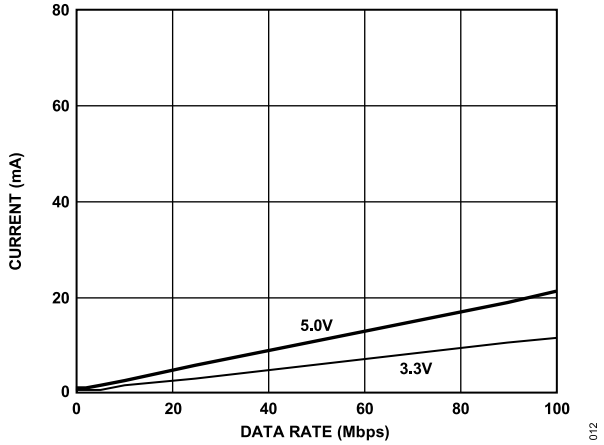


Figure 12. Typical ADuM4400 V_{DD2} Supply Current vs. Data Rate for 5 V and 3 V Operation

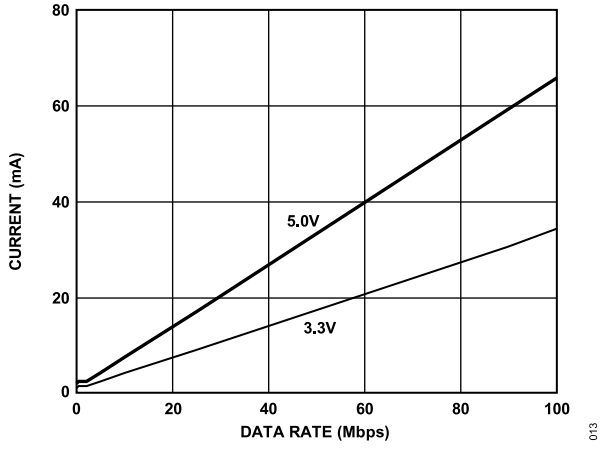


Figure 13. Typical ADuM4401 V_{DD1} Supply Current vs. Data Rate for 5 V and 3.3 V Operation

TYPICAL PERFORMANCE CHARACTERISTICS

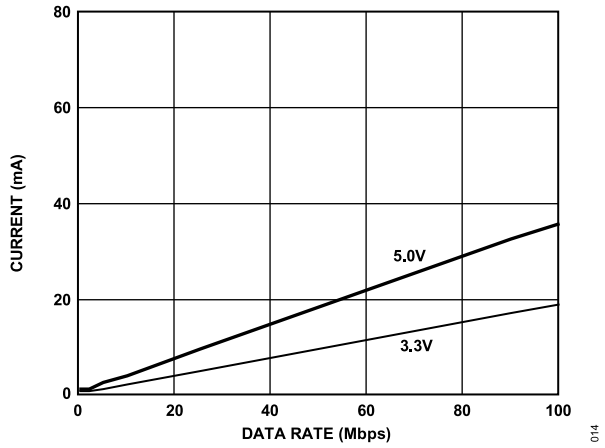


Figure 14. Typical ADuM4401 V_{DD2} Supply Current vs. Data Rate for 5 V and 3.3 V Operation

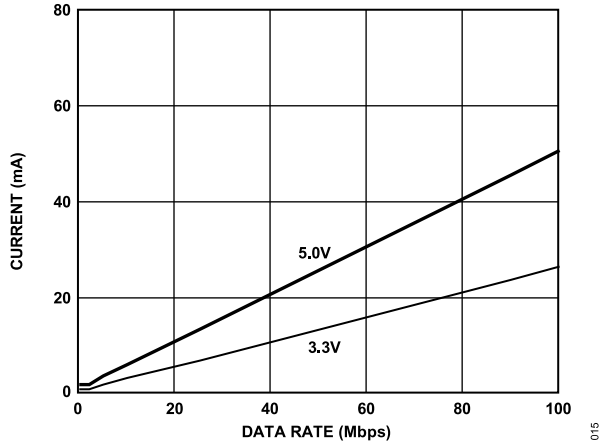


Figure 15. Typical ADuM4402 V_{DD1} or V_{DD2} Supply Current vs. Data Rate for 5 V and 3.3 V Operation

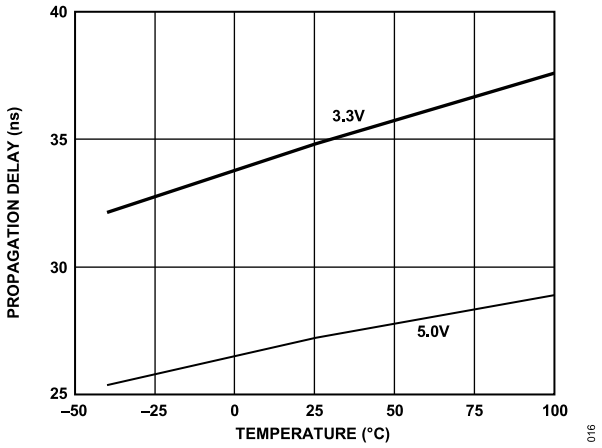


Figure 16. Propagation Delay vs. Temperature, C Grade

APPLICATIONS INFORMATION

PC BOARD LAYOUT

The ADuM440x digital isolators require no external interface circuitry for the logic interfaces. Power supply bypassing is strongly recommended at the input and output supply pins (see Figure 17). Bypass capacitors are most conveniently connected between Pin 1 and Pin 2 for V_{DD1} and between Pin 15 and Pin 16 for V_{DD2}. The capacitor value should be between 0.01 µF and 0.1 µF. The total lead length between both ends of the capacitor and the input power supply pin should not exceed 20 mm. Bypassing between Pin 1 and Pin 8 and between Pin 9 and Pin 16 should also be considered unless the ground pair on each package side are connected close to the package.

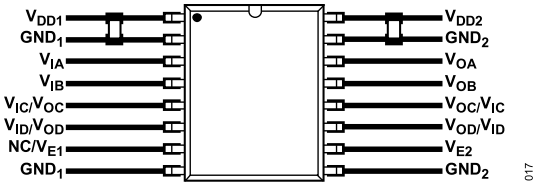


Figure 17. Recommended Printed Circuit Board Layout

In applications involving high common-mode transients, ensure that board coupling across the isolation barrier is minimized. Furthermore, the board layout should be designed such that any coupling that does occur equally affects all pins on a given component side. Failure to ensure this could cause voltage differentials between pins exceeding the Absolute Maximum Ratings of the device, thereby leading to latch-up or permanent damage.

See the AN-1109 Application Note for board layout guidelines.

SYSTEM-LEVEL ESD CONSIDERATIONS AND ENHANCEMENTS

System-level ESD reliability (for example, per IEC 61000-4-x) is highly dependent on system design, which varies widely by application. The ADuM440x incorporate many enhancements to make ESD reliability less dependent on system design. The enhancements include

- ESD protection cells added to all input/output interfaces.
- Key metal trace resistances reduced using wider geometry and paralleling of lines with vias.
- The SCR effect, inherent in CMOS devices, minimized by using guarding and isolation techniques between PMOS and NMOS devices.
- Areas of high electric field concentration eliminated using 45° corners on metal traces.
- Supply pin overvoltage prevented with larger ESD clamps between each supply pin and its respective ground.

While the ADuM440x improve system-level ESD reliability, they are no substitute for a robust system-level design. See the AN-793 Application Note, *ESD/Latch-Up Considerations with iCoupler Isolation Products*, for detailed recommendations on board layout and system-level design.

PROPAGATION DELAY-RELATED PARAMETERS

Propagation delay is a parameter that describes the length of time for a logic signal to propagate through a component. The propagation delay to a logic low output can differ from the propagation delay to logic high.

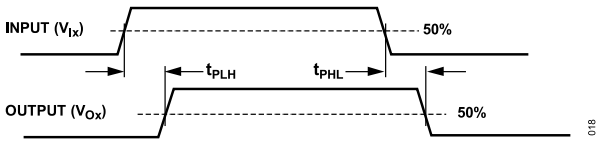


Figure 18. Propagation Delay Parameters

Pulse width distortion is the maximum difference between these two propagation delay values and is an indication of how accurately the input signal's timing is preserved.

Channel-to-channel matching refers to the maximum amount the propagation delay differs among channels within a single ADuM440x component.

Propagation delay skew refers to the maximum amount the propagation delay differs among multiple ADuM440x components operated under the same conditions.

DC CORRECTNESS AND MAGNETIC FIELD IMMUNITY

Positive and negative logic transitions at the isolator input cause narrow (~1 ns) pulses to be sent via the transformer to the decoder. The decoder is bistable and is therefore either set or reset by the pulses, indicating input logic transitions. In the absence of logic transitions at the input for more than ~1 µs, a periodic set of refresh pulses indicative of the correct input state are sent to ensure dc correctness at the output. If the decoder receives no internal pulses for more than approximately 5 µs, the input side is assumed to be without power or nonfunctional; in which case, the isolator output is forced to a default state (see Table 20) by the watchdog timer circuit.

The limitation on the ADuM440x magnetic field immunity is set by the condition in which induced voltage in the trans-former's receiving coil is large enough to either falsely set or reset the decoder. The following analysis defines the conditions under which this can occur. The 3 V operating condition of the ADuM440x is examined because it represents the most susceptible mode of operation.

The pulses at the transformer output have an amplitude greater than 1.0 V. The decoder has a sensing threshold at about 0.5 V, thereby establishing a 0.5 V margin in which induced voltages can be tolerated. The voltage induced across the receiving coil is given by

$$V = (-d\beta/dt)\Sigma\prod r_n^2;\ n = 1, 2, \ldots, N \quad (1)$$

APPLICATIONS INFORMATION

where:
β is the magnetic flux density (gauss).
N is the number of turns in the receiving coil.
r_n is the radius of the nth turn in the receiving coil (cm).

Given the geometry of the receiving coil in the ADuM440x and an imposed requirement that the induced voltage be at most 50% of the 0.5 V margin at the decoder, a maximum allowable magnetic field is calculated as shown in Figure 19.

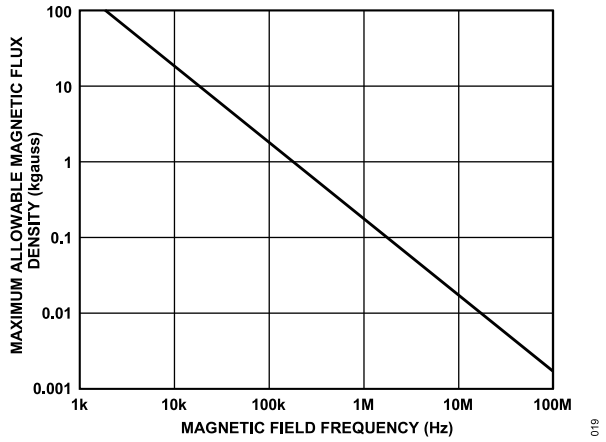


Figure 19. Maximum Allowable External Magnetic Flux Density

For example, at a magnetic field frequency of 1 MHz, the maximum allowable magnetic field of 0.2 kgauss induces a voltage of 0.25 V at the receiving coil. This is about 50% of the sensing threshold and does not cause a faulty output transition. Similarly, if such an event were to occur during a transmitted pulse (and was of the worst-case polarity), it would reduce the received pulse from >1.0 V to 0.75 V—still well above the 0.5 V sensing threshold of the decoder.

The preceding magnetic flux density values correspond to specific current magnitudes at given distances away from the ADuM440x transformers. Figure 20 expresses these allowable current magnitudes as a function of frequency for selected distances. As can be seen, the ADuM440x are immune and can be affected only by extremely large currents operated at high frequency and very close to the component. For the 1 MHz example noted, one would have to place a 0.5 kA current 5 mm away from the ADuM440x to affect the component's operation.

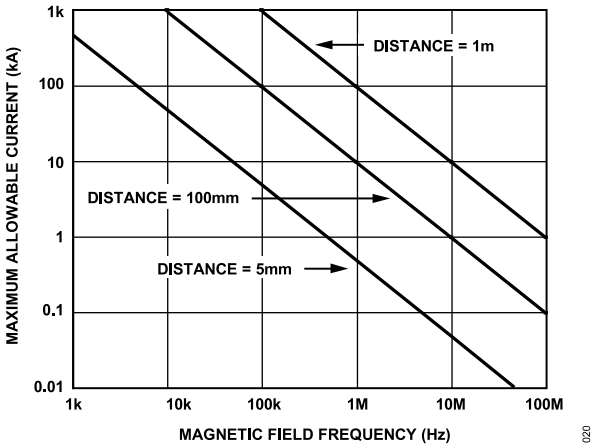


Figure 20. Maximum Allowable Current for Various Current-to-ADuM440x Spacings

Note that at combinations of strong magnetic field and high frequency, any loops formed by printed circuit board traces may induce sufficiently large error voltages to trigger the thresholds of succeeding circuitry. Care should be taken in the layout of such traces to avoid this possibility.

POWER CONSUMPTION

The supply current at a given channel of the ADuM440x isolator is a function of the supply voltage, the channel's data rate, and the channel's output load.

For each input channel, the supply current is given by

$$I_{DDI} = I_{DDI\,(Q)}\ f \le 0.5 f_r \quad (2)$$

$$I_{DDI} = I_{DDI\,(D)} \times (2f - f_r) + I_{DDI\,(Q)}\ f > 0.5 f_r \quad (3)$$

For each output channel, the supply current is given by:

$$I_{DDO} = I_{DDO\,(Q)}\ f \le 0.5 f_r \quad (4)$$

$$I_{DDO} = (I_{DDO\,(D)} + (0.5 \times 10^{-3}) \times C_L V_{DDO}) \times (2f - f_r) + I_{DDO\,(Q)} \quad (5)$$

$$f > 0.5 f_r \quad (6)$$

where:
$I_{DDI\,(D)}$, $I_{DDO\,(D)}$ are the input and output dynamic supply currents per channel (mA/Mbps).
C_L is the output load capacitance (pF).
V_{DDO} is the output supply voltage (V).
f is the input logic signal frequency (MHz, half of the input data rate, NRZ signaling).
f_r is the input stage refresh rate (Mbps).
$I_{DDI\,(Q)}$, $I_{DDO\,(Q)}$ are the specified input and output quiescent supply currents (mA).

To calculate the total I_{DD1} and I_{DD2}, the supply currents for each input and output channel corresponding to I_{DD1} and I_{DD2} are calculated and totaled. Figure 8 and Figure 9 provide per channel supply currents as a function of data rate for an unloaded output condition. Figure 10 provides per channel supply current as a

APPLICATIONS INFORMATION

function of data rate for a 15 pF output condition. Figure 11 through Figure 15 provide total I_{DD1} and I_{DD2} as a function of data rate for ADuM4400/ADuM4401/ADuM4402 channel configurations.

INSULATION LIFETIME

All insulation structures eventually break down when subjected to voltage stress over a sufficiently long period. The rate of insulation degradation is dependent on the characteristics of the voltage waveform applied across the insulation. In addition to the testing performed by the regulatory agencies, Analog Devices carries out an extensive set of evaluations to determine the lifetime of the insulation structure within the ADuM440x.

Analog Devices performs accelerated life testing using voltage levels higher than the rated continuous working voltage. Acceleration factors for several operating conditions are determined. These factors allow calculation of the time to failure at the actual working voltage. The values shown in Table 19 summarize the maximum continuous working voltages as per IEC 60747-17. Operation at working voltages higher than the service life voltage listed leads to premature insulation failure.

OUTLINE DIMENSIONS

Package Drawing (Option)	Package Type	Package Description
RW-16	SOIC_W	16-Lead Standard Small Outline Package
RI-16-2	SOIC_IC	16-Lead Standard Small Outline Package, with Increased Creepage

For the latest package outline information and land patterns (footprints), go to Package Index.

ORDERING GUIDE

Model[1, 2]	Temperature Range	Package Description	Packing Quantity	Package Option
ADuM4400ARWZ	−40°C to +105°C	16-Lead SOIC_W	Tube, 47	RW-16
ADuM4400ARWZ-RL	−40°C to +105°C	16-Lead SOIC_W	Reel, 1000	RW-16
ADuM4400BRWZ	−40°C to +105°C	16-Lead SOIC_W	Tube, 47	RW-16
ADuM4400BRWZ-RL	−40°C to +105°C	16-Lead SOIC_W	Reel, 1000	RW-16
ADuM4400CRWZ	−40°C to +105°C	16-Lead SOIC_W	Tube, 47	RW-16
ADuM4400CRWZ-RL	−40°C to +105°C	16-Lead SOIC_W	Reel, 1000	RW-16
ADuM4400ARIZ	−40°C to +105°C	16-Lead SOIC_IC	Tube, 37	RI-16-2
ADuM4400ARIZ-RL	−40°C to +105°C	16-Lead SOIC_IC	Reel, 1000	RI-16-2
ADuM4400BRIZ	−40°C to +105°C	16-Lead SOIC_IC	Tube, 37	RI-16-2
ADuM4400BRIZ-RL	−40°C to +105°C	16-Lead SOIC_IC	Reel, 1000	RI-16-2
ADuM4400CRIZ	−40°C to +105°C	16-Lead SOIC_IC	Tube, 37	RI-16-2
ADuM4400CRIZ-RL	−40°C to +105°C	16-Lead SOIC_IC	Reel, 1000	RI-16-2
ADuM4401ARWZ	−40°C to +105°C	16-Lead SOIC_W	Tube, 47	RW-16
ADuM4401ARWZ-RL	−40°C to +105°C	16-Lead SOIC_W	Reel, 1000	RW-16
ADuM4401BRWZ	−40°C to +105°C	16-Lead SOIC_W	Tube, 47	RW-16
ADuM4401BRWZ-RL	−40°C to +105°C	16-Lead SOIC_W	Reel, 1000	RW-16
ADuM4401CRWZ	−40°C to +105°C	16-Lead SOIC_W	Tube, 47	RW-16
ADuM4401CRWZ-RL	−40°C to +105°C	16-Lead SOIC_W	Reel, 1000	RW-16
ADuM4401ARIZ	−40°C to +105°C	16-Lead SOIC_IC	Tube, 37	RI-16-2
ADuM4401ARIZ-RL	−40°C to +105°C	16-Lead SOIC_IC	Reel, 1000	RI-16-2
ADuM4401BRIZ	−40°C to +105°C	16-Lead SOIC_IC	Tube, 37	RI-16-2
ADuM4401BRIZ-RL	−40°C to +105°C	16-Lead SOIC_IC	Reel, 1000	RI-16-2
ADuM4401CRIZ	−40°C to +105°C	16-Lead SOIC_IC	Tube, 37	RI-16-2
ADuM4401CRIZ-RL	−40°C to +105°C	16-Lead SOIC_IC	Reel, 1000	RI-16-2
ADuM4402ARWZ	−40°C to +105°C	16-Lead SOIC_W	Tube, 47	RW-16
ADuM4402ARWZ-RL	−40°C to +105°C	16-Lead SOIC_W	Reel, 1000	RW-16
ADuM4402BRWZ	−40°C to +105°C	16-Lead SOIC_W	Tube, 47	RW-16
ADuM4402BRWZ-RL	−40°C to +105°C	16-Lead SOIC_W	Reel, 1000	RW-16
ADuM4402CRWZ	−40°C to +105°C	16-Lead SOIC_W	Tube, 47	RW-16
ADuM4402CRWZ-RL	−40°C to +105°C	16-Lead SOIC_W	Reel, 1000	RW-16
ADuM4402ARIZ	−40°C to +105°C	16-Lead SOIC_IC	Tube, 37	RI-16-2
ADuM4402ARIZ-RL	−40°C to +105°C	16-Lead SOIC_IC	Reel, 1000	RI-16-2
ADuM4402BRIZ	−40°C to +105°C	16-Lead SOIC_IC	Tube, 37	RI-16-2
ADuM4402BRIZ-RL	−40°C to +105°C	16-Lead SOIC_IC	Reel, 1000	RI-16-2
ADuM4402CRIZ	−40°C to +105°C	16-Lead SOIC_IC	Tube, 37	RI-16-2
ADuM4402CRIZ-RL	−40°C to +105°C	16-Lead SOIC_IC	Reel, 1000	RI-16-2

[1] Tape and reel is available. The addition of an -RL suffix designates a 13" (1,000 units) tape and reel option.

[2] Z = RoHS Compliant Part.

OUTLINE DIMENSIONS

NUMBER OF INPUTS, MAXIMUM DATA RATE, MAXIMUM PROPAGATION DELAY, AND MAXIMUM PULSE WIDTH DISTORTION OPTIONS

Model[1, 2]	Number of Inputs, V_{DD1} Side	Number of Inputs, V_{DD2} Side	Maximum Data Rate (Mbps)	Maximum Propagation Delay, 5 V (ns)	Maximum Pulse Width Distortion (ns)
ADuM4400ARWZ	4	0	1	100	40
ADuM4400ARWZ-RL	4	0	1	100	40
ADuM4400BRWZ	4	0	10	50	3
ADuM4400BRWZ-RL	4	0	10	50	3
ADuM4400CRWZ	4	0	90	32	2
ADuM4400CRWZ-RL	4	0	90	32	2
ADuM4400ARIZ	4	0	1	100	40
ADuM4400ARIZ-RL	4	0	1	100	40
ADuM4400BRIZ	4	0	10	50	3
ADuM4400BRIZ-RL	4	0	10	50	3
ADuM4400CRIZ	4	0	90	32	2
ADuM4400CRIZ-RL	4	0	90	32	2
ADuM4401ARWZ	3	1	1	100	40
ADuM4401ARWZ-RL	3	1	1	100	40
ADuM4401BRWZ	3	1	10	50	3
ADuM4401BRWZ-RL	3	1	10	50	3
ADuM4401CRWZ	3	1	90	32	2
ADuM4401CRWZ-RL	3	1	90	32	2
ADuM4401ARIZ	3	1	1	100	40
ADuM4401ARIZ-RL	3	1	1	100	40
ADuM4401BRIZ	3	1	10	50	3
ADuM4401BRIZ-RL	3	1	10	50	3
ADuM4401CRIZ	3	1	90	32	2
ADuM4401CRIZ-RL	3	1	90	32	2
ADuM4402ARWZ	2	2	1	100	40
ADuM4402ARWZ-RL	2	2	1	100	40
ADuM4402BRWZ	2	2	10	50	3
ADuM4402BRWZ-RL	2	2	10	50	3
ADuM4402CRWZ	2	2	90	32	2
ADuM4402CRWZ-RL	2	2	90	32	2
ADuM4402ARIZ	2	2	1	100	40
ADuM4402ARIZ-RL	2	2	1	100	40
ADuM4402BRIZ	2	2	10	50	3
ADuM4402BRIZ-RL	2	2	10	50	3
ADuM4402CRIZ	2	2	90	32	2
ADuM4402CRIZ-RL	2	2	90	32	2

[1] Tape and reel is available. The addition of an -RL suffix designates a 13" (1,000 units) tape and reel option.

[2] Z = RoHS Compliant Part.